

# **NCE Automotive N-Channel Super Trench Power MOSFET**

### **Description**

The series of devices uses **Super Trench** technology that is uniquely optimized to provide the most efficient high frequency switching performance. Both conduction and switching power losses are minimized due to an extremely low combination of  $R_{DS(ON)}$  and  $Q_g$ . This device is ideal for high-frequency switching and synchronous rectification.

## **Application**

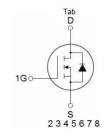
- Automotive application
- DC/DC Converter
- Ideal for high-frequency switching and synchronous rectification

# **General Features**

- $V_{DS}$  =150V, $I_D$  =165A  $R_{DS(ON)}$ =5.2m $\Omega$  , typical@  $V_{GS}$ =10V
- Excellent gate charge x R<sub>DS(on)</sub> product(FOM)
- Very low on-resistance R<sub>DS(on)</sub>
- 175 °C operating temperature
- Pb-free lead plating
- 100% UIS tested
- 100% ΔVds tested
- AEC-Q101 qualified







**Schematic Diagram** 

### **Package Marking and Ordering Information**

Device Marking	Device	Device Package	Reel Size	Tape width	Quantity
AP15T14LL	NCEAP15T14LL	TOLL-8L	-	-	-

# Absolute Maximum Ratings (T<sub>c</sub>=25℃unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V <sub>DS</sub>	150	V
Gate-Source Voltage	V <sub>G</sub> s	±20	V
Drain Current-Continuous	I <sub>D</sub>	165	А
Drain Current-Continuous	I <sub>D</sub> (T <sub>C</sub> =100°C)	117	А
Pulsed Drain Current	I <sub>DM</sub>	660	А
Maximum Power Dissipation	P <sub>D</sub>	375	W
Derating factor		2.5	W/°C
Single pulse avalanche energy (Note 1)	E <sub>AS</sub>	1764	mJ
Operating Junction and Storage Temperature Range	$T_{J}, T_{STG}$	-55 To 175	$^{\circ}$

#### **Thermal Characteristic**

Thermal Resistance,Junction-to-Case	Rejc	0.4	°C/W
Thermal Resistance, Junction-to-Ambient (Note 4)	R <sub>θJA</sub>	40	°C/W

# NCEAP15T14LL

# Electrical Characteristics (T<sub>C</sub>=25°C unless otherwise noted)

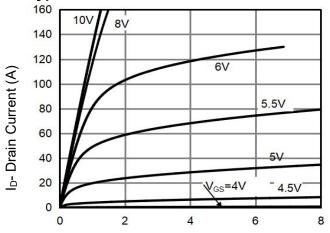
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V I <sub>D</sub> =250μA	150	-	-	V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	V <sub>DS</sub> =150V,V <sub>GS</sub> =0V	-	-	1	μA
Gate-Body Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V,V <sub>DS</sub> =0V	-	-	±100	nA
On Characteristics						
Gate Threshold Voltage	V <sub>GS(th)</sub>	$V_{DS}=V_{GS},I_{D}=250\mu A$	2.0	3.0	4.0	V
Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =40A	-	5.2	5.8	mΩ
Gate resistance	R <sub>G</sub>	F=1.0MHz	-	3.3	-	Ω
Forward Transconductance	<b>g</b> FS	V <sub>DS</sub> =10V,I <sub>D</sub> =40A	-	59	-	S
Dynamic Characteristics						
Input Capacitance	Clss	75/// 01/	-	6100	-	pF
Output Capacitance	Coss	$V_{DS}=75V, V_{GS}=0V,$	-	700	-	PF
Reverse Transfer Capacitance	Crss	F=1.0MHz	-	31	-	pF
Switching Characteristics (Note 2)						
Turn-on Delay Time	t <sub>d(on)</sub>		-	26	-	nS
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =75 $V$ , $I_D$ =70 $A$	-	36	-	nS
Turn-Off Delay Time	t <sub>d(off)</sub>	$V_{GS}$ =10 $V$ , $R_{G}$ =4.7 $\Omega$	-	47	-	nS
Turn-Off Fall Time	t <sub>f</sub>		-	15	-	nS
Total Gate Charge	Qg	V <sub>DS</sub> =75V,I <sub>D</sub> =20A,	-	90	-	nC
Gate-Source Charge	Q <sub>gs</sub>		-	30	-	nC
Gate-Drain Charge	Q <sub>gd</sub>	V <sub>GS</sub> =10V	-	22	-	nC
Drain-Source Diode Characteristics						
Diode Forward Voltage	V <sub>SD</sub>	V <sub>GS</sub> =0V,I <sub>F</sub> =40A	-	-	1.2	V
Diode Forward Current	Is		-	-	165	Α
Reverse Recovery Time	t <sub>rr</sub>	T <sub>J</sub> = 25°C, I <sub>F</sub> = I <sub>S</sub>	-	146	-	nS
Reverse Recovery Charge	Qrr	di/dt = 100A/μs	-	485	-	nC

#### Notes:

- 1. EAS condition : Tj=25  $^{\circ}\text{C,VDD}$ =50V,VG=10V,L=0.5mH,Rg=25 $\Omega$
- 2. Guaranteed by design, not subject to production
- 3. These curves are based on the junction-to-case thermal impedance which is measured with the device mounted to a large heatsink, assuming a maximum junction temperature of T<sub>J(MAX)</sub>=175° C. The SOA curve provides a single pulse rating.
- 4. The value of  $R_{\text{BJA}}$  is measured with the device mounted on 1in2 FR-4 board with 2oz. Copper, in a still air environment with  $T_{\text{A}}$  =25° C. The maximum allowed junction temperature of 175° C. The value in any given application depends on the user's specific board design.

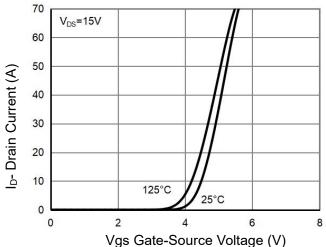


## **Typical Electrical and Thermal Characteristics**



Vds Drain-Source Voltage (V)

# **Figure 1 Output Characteristics**



**Figure 2 Transfer Characteristics** 

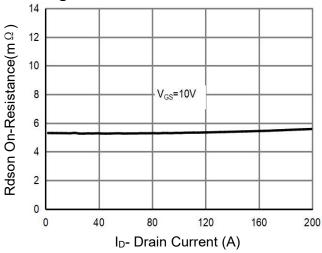


Figure 3 Rdson- Drain Current

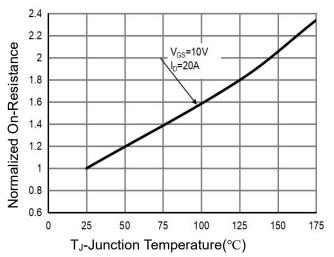


Figure 4 Rdson-JunctionTemperature

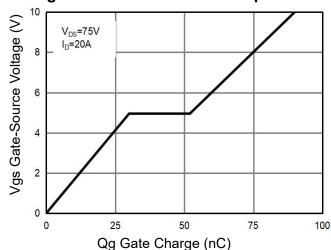


Figure 5 Gate Charge

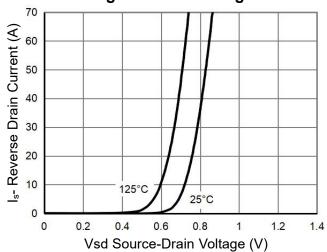
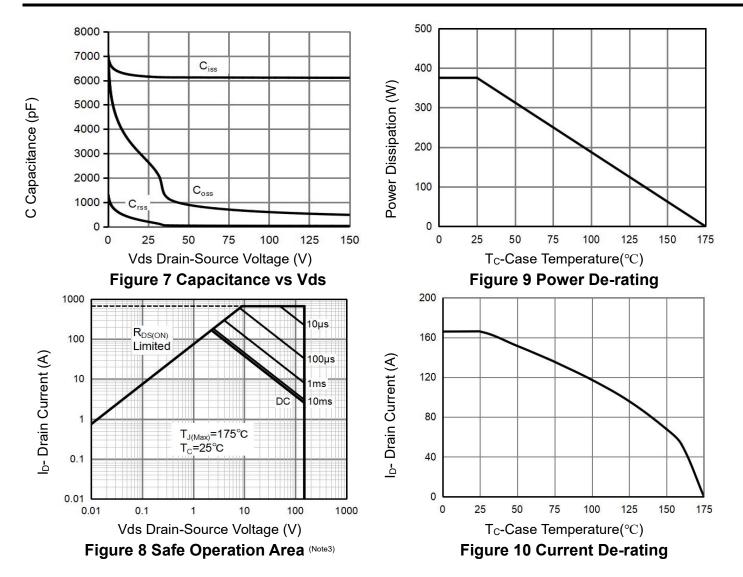


Figure 6 Source- Drain Diode Forward





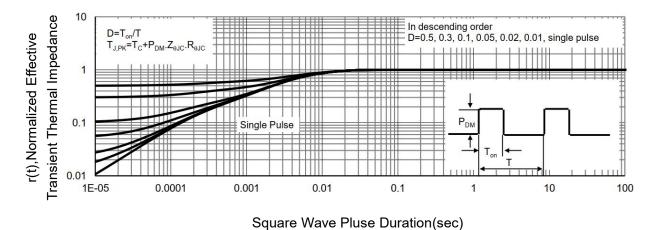
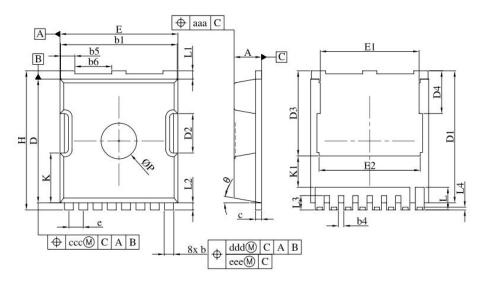
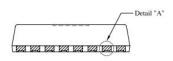


Figure 11 Normalized Maximum Transient Thermal Impedance



# **TOLL-8L Package Information**







S		COMMON				
M B O	MILLIMETER					
L L	MIN.	NOMINAL	MAX.			
A	2.20	2.30	2.40			
b	0.70	0.80	0.90			
bl	9.70	9.80	9.90			
b2	0.36	0.45	0.55			
b3	0.05	0.100	0.35			
b4	0.30	0.40	0.50			
b5	1.10	1.20	1.30			
b6	3.00	3.10	3.20			
С	0.40	0.50	0.60			
D	10.28	10.38	10.55			
D1	10.98	11.08	11.18			
D2	3.20	3.30	3.40			
D3	7.00	7.15	7.30			
D4	3.44	3.59	3.74			
е	1.10	1.20	1.30			
Е	9.80	9.90	10.00			
El	8.20	8.30	8.40			
E2	8.35	8.50	8.65			
Н	11.50	11.68	11.85			
K	4.08	4.18	4.28			
K1	2.45					
L	1.60	1.90	2.10			
L1	0.50	0.70	0.90			
L2	0.50	0.60	0.70			
L3	1.00	1.20	1.30			
L4	0.13	0.23	0.33			
P	2.85	3.00	3.15			
θ	10° REF					
aaa	0.20					
ccc	0.20					
ddd	0.25					
eee		0.20				



#### http://www.ncepower.com

# NCEAP15T14LL

# **Revision History**

Revision	Date	Subjects
V1.0	2024.12.09	Product data sheet

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